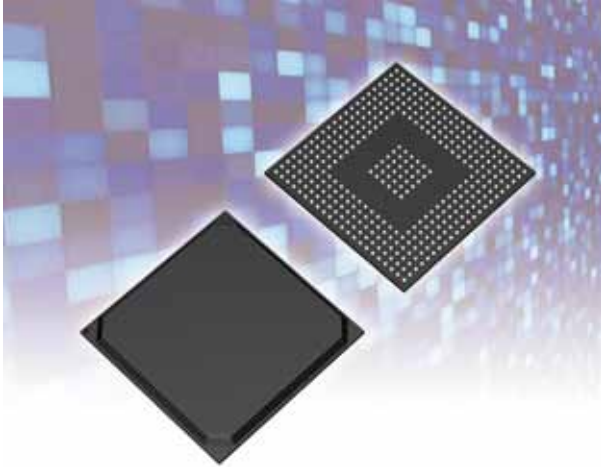


## Product Overview



### ML7831

パッケージ : PBGA376

- Connects to E600 via PCI Express® x1
- Pin-compatible with Intel's® EG20T Platform Controller Hub LSI
- Compatible device drivers (except for vendor IDs)
- Supports temperature ranges required for industrial applications
- Optimized for use with ROHM PMICs (Power Management ICs) and CGICs (Clock Generator ICs) for Intel® Atom™ E600

|      |     |            |
|------|-----|------------|
| PMIC | 5V  | BD9591AMWV |
|      | 12V | BD9594AMWV |
| CGIC |     | BU7335MWV  |

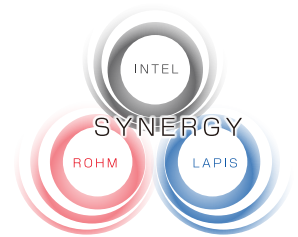
## Major Specification

- Operating voltages: 1.2V, 2.5V, 3.3V
- Operating Temperature : -40 to +85 °C
- Package: PBGA376
- Functions
  - PCI Express® 1.1
  - USB2.0 Host (HS/FS/LS) with DMA
  - USB2.0 Device (HS/FS) with DMA
  - SD Host with DMA (supports SDIO; 32GB max.)
  - Serial ATA II with DMA
  - Gigabit Ethernet MAC with DMA (supports Jumbo Frame)
  - 8-line UART with 256-byte FIFO
  - 2-line UART (TXD, RXD) with 64-byte FIFO
  - SPI · I2C · GPIO

## CHOOSE A JUST-FIT IOH FOR BOM REDUCTION\*1 !

The ML7831 is an IOH (Input/Output Hub) LSI designed to connect to Intel® Atom™ processor E600 via PCI Express®. LAPIS Semiconductor characterizes the ML7831 as a cost-optimized version to Intel® Platform Controller Hub LSI, EG20T (formerly known as Topcliff) while it still keeps pin-compatibility to the EG20T.

Not only the pin-compatibility to the EG20T but also common device driver software makes your re-engineering workload as minimized as possible.

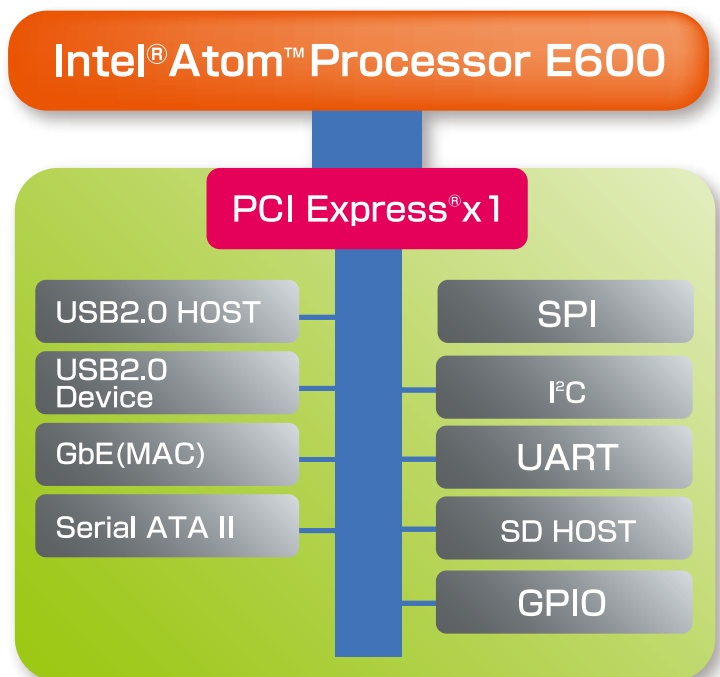


\*1) Pricing depends on a number of variables, including the order quantity and supply chain. Therefore, specific prices cannot be guaranteed.

### Application Examples

- Industrial PC
- Thin Client
- Point-of-Sales
- Digital signage
- FA (Factory Automation) equipment
- And more

## Block Diagrams



For more information, please contact your closest ROHM sales office.